Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.					der both lev	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1	IDC Web Site for Information on IDC 1752 Standard Form Type				Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				eous Materia	ials and Mfg Information				
Supplie	r Information														
Company name* Company unique ID				ique ID	Unique II			ique ID Authority				Response Date*			
onsemi											2025-05-12				
Contact Name T				Title - Contact			Phone - Contact*				Email - Contact*				
Product-l	Env-Stewards		Product Env	iro Compliance	) Compliance		NA				Product-Env-Stewards@onsemi.com				
Authorize	ed Representative*	Title - Repre	Title - Representative			Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com				
	1		Number Mfr Item Name			E	Effective Date	tive Date   Version   Manufacturing Site		Wei	ght*	UOM	Unit Type		
			ZEN SUR40 REG 5	5W 9.1V TR	2	2025-05-12 CNP			607.	)	mg	Each			
<b>Aanufa</b>	cturing Proccess Informa	tion													
	Terminal Plating / Grid Array Material T		Cerminal Base Alloy J-STD-020 M		STD-020 MSL R	ating	Peak Process Body Temperature Ma		erature Max T	ime at Peak	Temperature	Numbe	r of Reflow Cyc	eles	
	Matte Tin (Sn) - annealed		CU Alloy NA		<b>A</b>		0 C 30			seconds 3					
omments															
or more	information regarding material	aammaaitian	nlagge wefer to	. maga 2											

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale app										
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	es per the definition above except for selected exemp	otions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		'Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	astislav Drska	-6_								

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.5	mg	Supplier	Silicon (Si)	7440-21-3		4.5	mg
Die Attach Solder	21.29	mg	Supplier	Silver (Ag)	7440-22-4		0.5323	mg
			A	Lead (Pb)	7439-92-1	7a	19.6933	mg
			Supplier	Tin (Sn)	7440-31-5		1.0645	mg
Lead Frame	333.62	mg	В	Nickel (Ni)	7440-02-0		3.6698	mg
			Supplier	Copper (Cu)	7440-50-8		329.9502	mg
Mold Compound-Black	239.19	mg		Metal Hydroxide	proprietary data		11.9595	mg
			Supplier	Carbon Black (C)	1333-86-4		2.3919	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		179.3925	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		23.919	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		21.5271	mg
Plating	8.4	mg	Supplier	Tin (Sn)	7440-31-5		8.4	mg